

Features

- Collector Current: I_C=-0.5A
- Power Dissipation of 300mW



SOT-23

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BC807-40,215	SOT-23	5C	3000



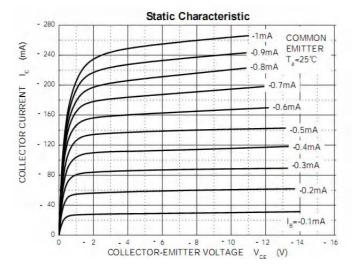
Maximum Ratings (Ta=25°C unless otherwise noted)

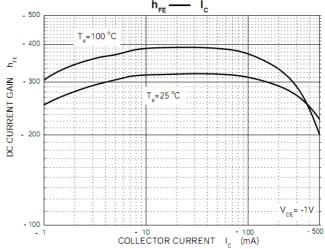
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-45	V
Emitter-Base Voltage	V _{EBO}	-5	V
Collector Current	I _c	-500	mA
Collector Power Dissipation	P _C	300	mW
Thermal Resistance From Junction To Ambient	R _{OJA}	417	°C/W
Junction Temperature	T _j	150	°C
Storage Temperature	T _{stg}	-55∼+150	°C

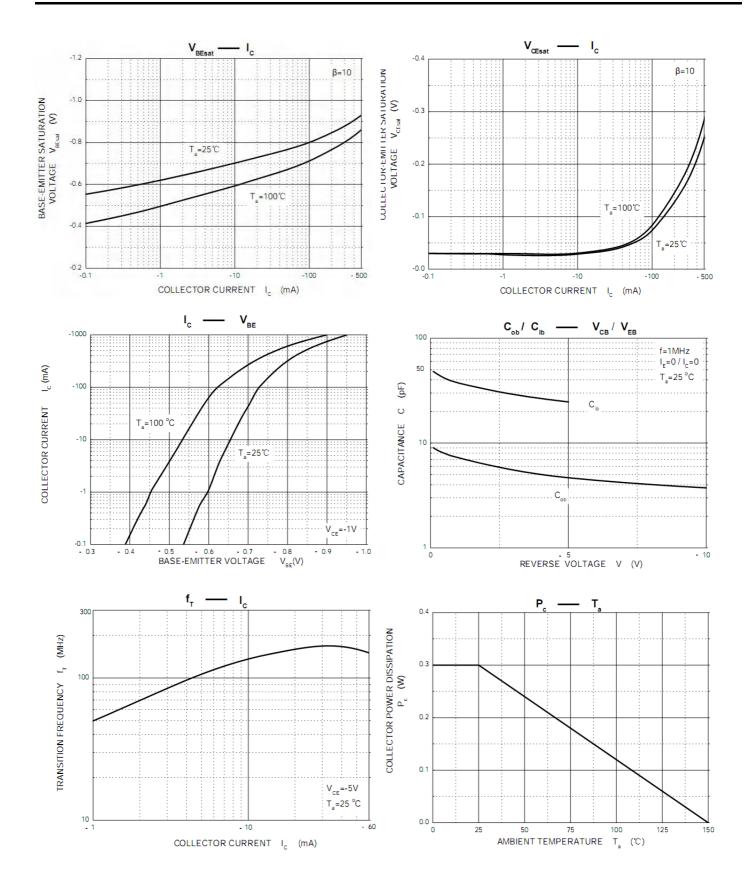
Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	V _{CBO}	I _C = -10μΑ, I _E =0	-50		V
Collector-emitter breakdown voltage	V _{CEO}	I _C = -10mA, I _B =0	-45		V
Emitter-base breakdown voltage	V _{EBO}	I _E = -1μΑ, I _C =0	-5		V
Collector cut-off current	I _{CBO}	V _{CB} = -45V, I _E =0		-0.1	μΑ
Emitter cut-off current	I _{EBO}	V _{EB} = -4 V, I _C =0		-0.1	μA
DC current gain	hFE(1)	V _{CE} = -1V, I _C = -100mA	250	600	
S	hFE(2)	V _{CE} = -1V, I _C = -500mA 40			
Collector-emitter saturation voltage	V _{CE} (sat)	I _C =-500mA, I _B = -50mA		-0.7	V
Base-emitter saturation voltage	V _{BE} (sat)	I _C = -500mA, I _B = -50mA		-1.2	V
Transition frequency	f⊤	V _{CE} = -5V, I _C = -10mA f=100MHz	100		MHz

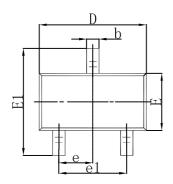
Typical Characteristics

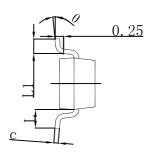


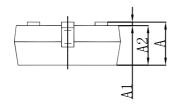




SOT-23 Package Outline Dimensions

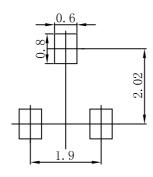






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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